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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Martin Hausner
Serial No.: Unknown (National Phase of International Application
PCT/EP03/09052)
Filed: February 11, 2005 (Priority Date Claimed August 14, 2002)
Art Unit: Unknown
Confirmation No.: Unknown
Examiner: Unknown
Title: **METHOD FOR SELECTIVELY REMOVING MATERIAL FROM THE
SURFACE OF A SUBSTRATE, MASKING MATERIAL FOR A
WAFER, AND WAFER WITH MASKING MATERIAL**
Our Ref. No.: BEET-09

Cincinnati, OH

February 11, 2005

Mail Stop PCT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT

Sir:

Prior to examination of the above-identified application, please amend
the application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on
page 2 of this paper.

Remarks/Arguments begin on page 10 of this paper.